

20V P-Channel Power MOSFET

UM8516 SOT23-6

General Description

The UM8516 is a low threshold P-channel MOSFET with gate to source TVS protection, have extremely low on-resistance. This benefit provides the designer with an extremely efficient device for use in battery and load management applications. The devices use a space-saving, small-outline SOT23-6 package.

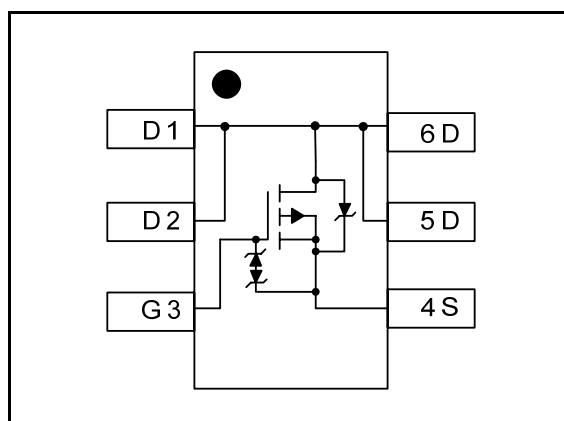
Applications

- Battery Packs
- Battery-powered Portable Equipment
- Cellular and Cordless Telephones

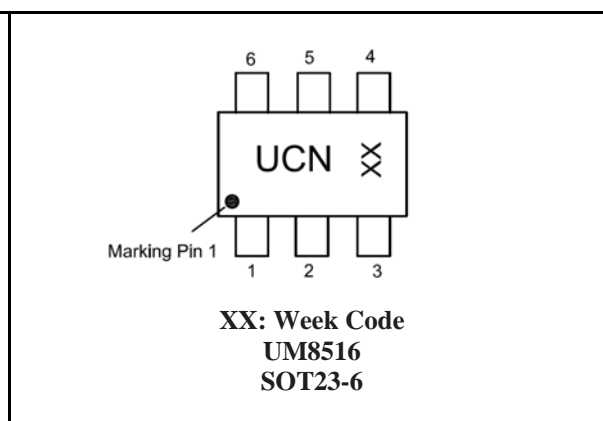
Features

- Drain-Source Voltage(max): -20V
- Low On-Resistance:
90mΩ@V_{GS}=-4.5V
110mΩ@V_{GS}=-2.5V
- Continuous Drain Current(max): -2A@25°C

Pin Configurations



Top View



Ordering Information

Part Number	Packaging Type	Marking Code	Shipping Qty
UM8516	SOT23-6	UCN	3000pcs/7 Inch Tape & Reel

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
V _{DSS}	Drain-Source voltage	-20	V
V _{GS}	Gate-Source voltage	±8	V
I _D	Continuous Drain Current	-2.0	A
I _{DM}	Drain Current Pulsed	-10	A
P _D	Power Dissipation	0.7	W
T _J	Junction Temperature	-55~150	°C
T _{stg}	Storage Temperature	-55~150	°C
R _{θJA}	Thermal Resistance, Junction-to-Ambient	100	°C/W

Electrical Characteristics (T_J=25°C, Unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
Off Characteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-20V, V _{GS} =0V			-1	μA
I _{GSS}	Gate-to-Source Leakage Current	V _{GS} =±6V, V _{DS} =0V			±1	μA
On Characteristics						
R _{DS(ON)}	Static Drain-to-Source On-Resistance	V _{GS} =-4.5V, I _D =-2.8A		90	110	mΩ
		V _{GS} =-2.5V, I _D =-2A		110	150	
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D =-250μA	-0.4	-0.6	-1	V
g _{fs}	Forward Transconductance	V _{DS} =-10V, I _D =-2.7A		7.0		S
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-15V, f=1.0MHz		480		pF
C _{oss}	Output Capacitance			46		
C _{rss}	Reverse Transfer Capacitance			10		
Switching Characteristics						
Q _{g(TOT)}	Total Gate Charge			7.2		
Q _{g(TH)}	Threshold Gate Charge	V _{DS} =-6V, V _{GS} =-4.5V, I _D =-2.8A		2.2		nC
Q _{gs}	Gate-Source Charge			2.2		
Q _{gd}	Gate-Drain Charge			1.2		
td(on)	Turn-on Delay Time	V _{GS} =-4.5V, V _{DS} =-6V, R _L =6Ω, R _G =6Ω		38		ns
t _r	Rise Time			25		
td(off)	Turn-off Delay Time			43		
t _f	Fall Time			5		
Drain-Source Diode Characteristics and Maximum Ratings						
V _{SD}	Forward Diode Voltage	V _{GS} =0V, I _S =-1A		-0.7	-1.4	V

Typical Characteristics ($T_J=25^\circ\text{C}$, Unless otherwise noted)

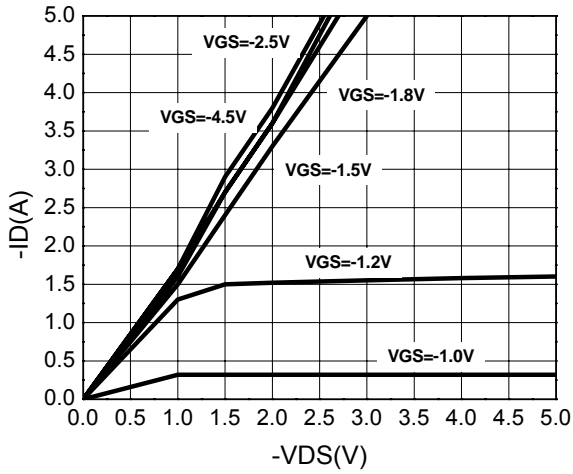


Fig1. Typical Output Characteristics

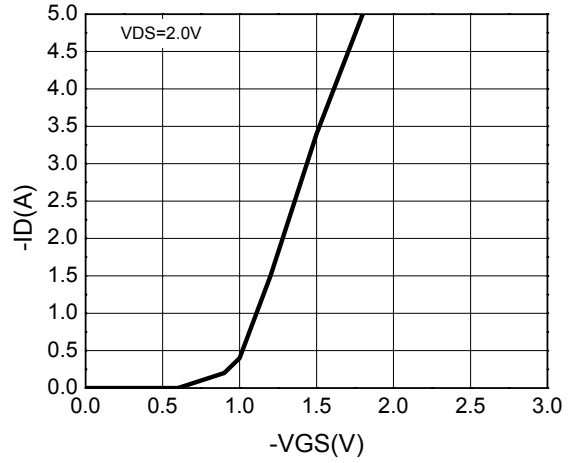


Fig2. Typical Transfer Characteristics

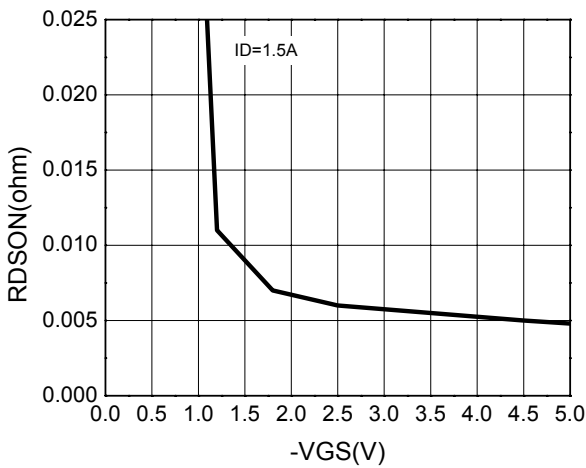


Fig3. On-Resistance vs. Gate-to-Source Voltage

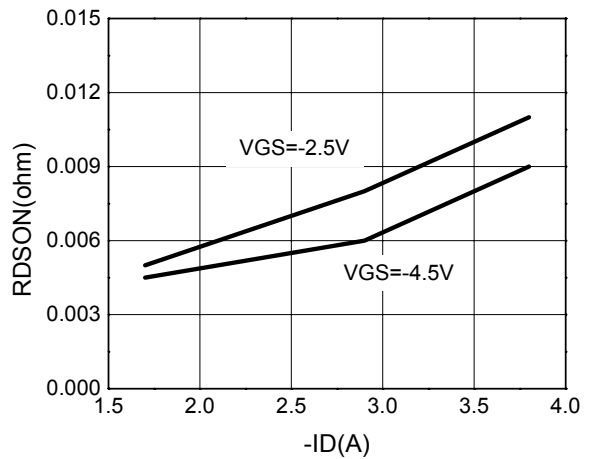


Fig4. On-Resistance vs. Drain Current

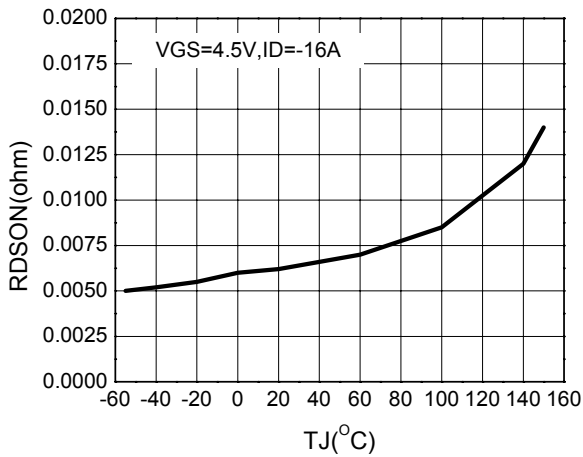


Fig5. On-Resistance vs. Junction Temperature

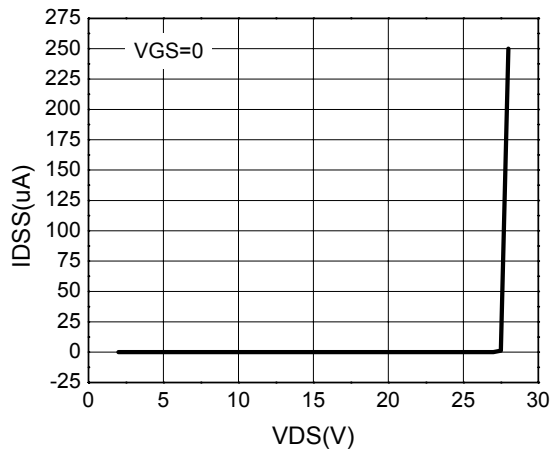


Fig6. IDS vs. Drain-to-Source Voltage

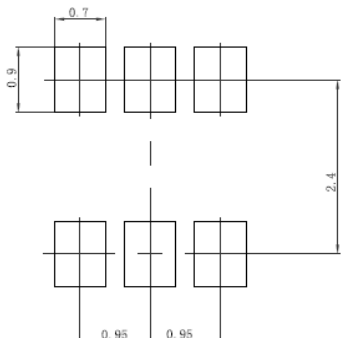
Package Information

UM8516 SOT23-6

Outline Drawing

DIMENSIONS				
Symbol	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950REF		0.037REF	
e1	1.800	2.000	0.071	0.079
L	0.600REF		0.023REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

Land Pattern

	<p>NOTES:</p> <ol style="list-style-type: none"> 1. Compound dimension: 2.92×1.60; 2. Unit: mm; 3. General tolerance ±0.05mm unless otherwise specified; 4. The layout is just for reference.
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Tape and Reel Orientation



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